

## About the presenter:

CJ Clark is the CEO of Intellitech Corp.

Prior: ITT Defense, Plantronics/Wilcom, Airex

IEEE Standards Medallion 2013 Award - Dec 2013

*For vision, leadership and exceptional dedication in enabling IEEE standards to lower costs for the electronics industry*

Elected IEEE 1149.1/JTAG Chairperson **1996-2001** & **2010-2013**

Active member of P1838, P1687, P1149.6, etc

VTS 2012 Best Special Session Award - "IEEE P1149.1-2013..."

Co-inventor on 40+ US/foreign patents related to FPGA/JTAG

UNH CEPS Advisory Board Member (2000 - 2013 Emeritus )



# What is 1149.1-2013 ... and what does it do for the industry

CJ Clark, Intellitech CEO

Chairman, IEEE 1149.1-2013



# IEEE 1149.1-2013 Executive Summary

- Standardizes a plug-n-play test interface to on-chip IP

## Mission IP

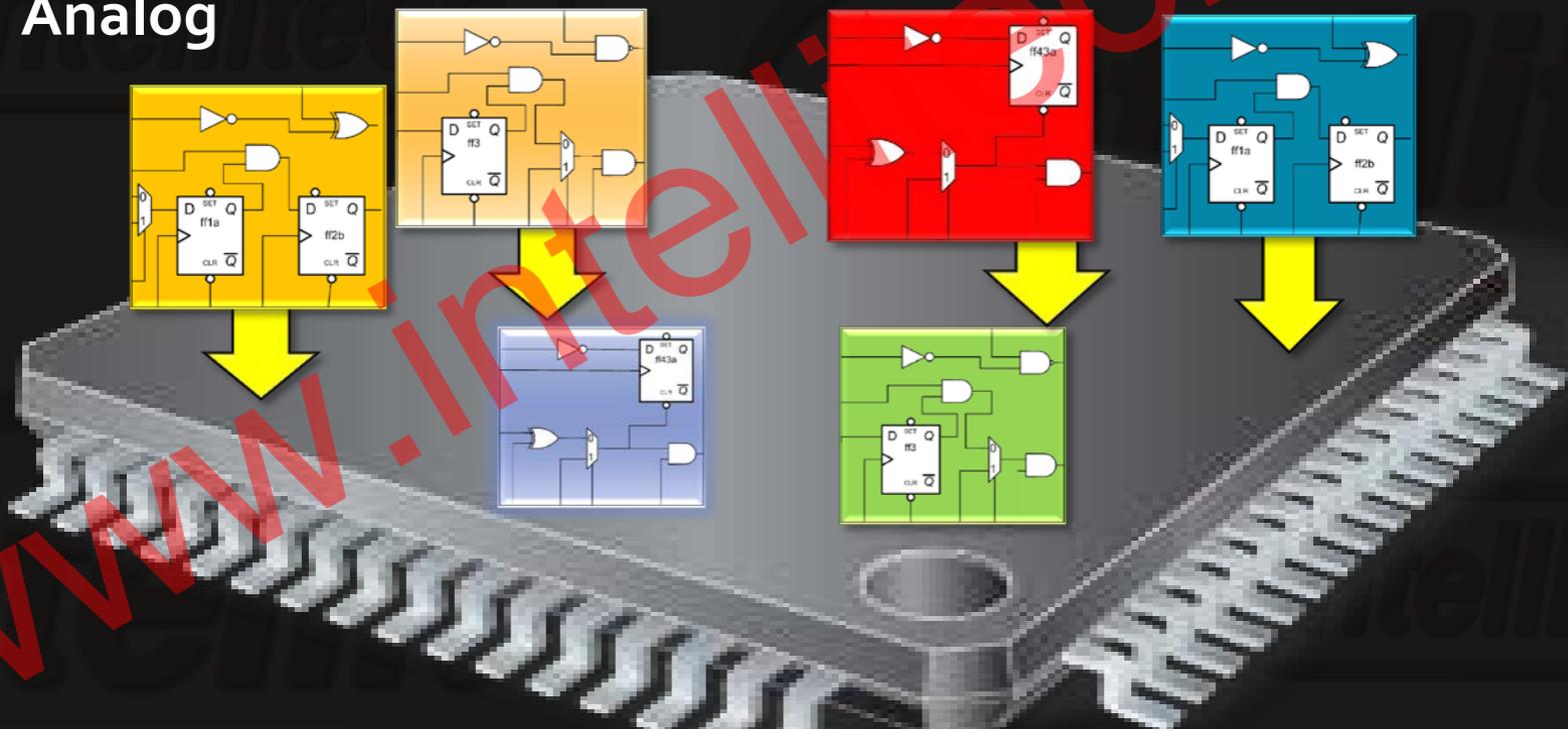
CPU  
DSP  
Memory  
Analog

Graphics  
Connectivity  
Etc.

## Infrastructure IP

Embedded Test  
Memory BISR  
SerDes BIST

Voltage/Temp  
Security  
Process monitors



See Yervant Zorian: "Infrastructure IP for SoCs" and "What is Infrastructure IP?"  
BIST = Built In Self-Test    BISR = Built-in Self-Repair

# 1149.1-2013 adds depth to the other half of the standard

- Standard Test Access Port and Boundary Scan architecture

"Boundary Scan" has always been a misnomer, it's only a part of the standard.

Standardization now available for all internal JTAG registers via the Test Access Port

Hierarchical descriptions of on-chip IP

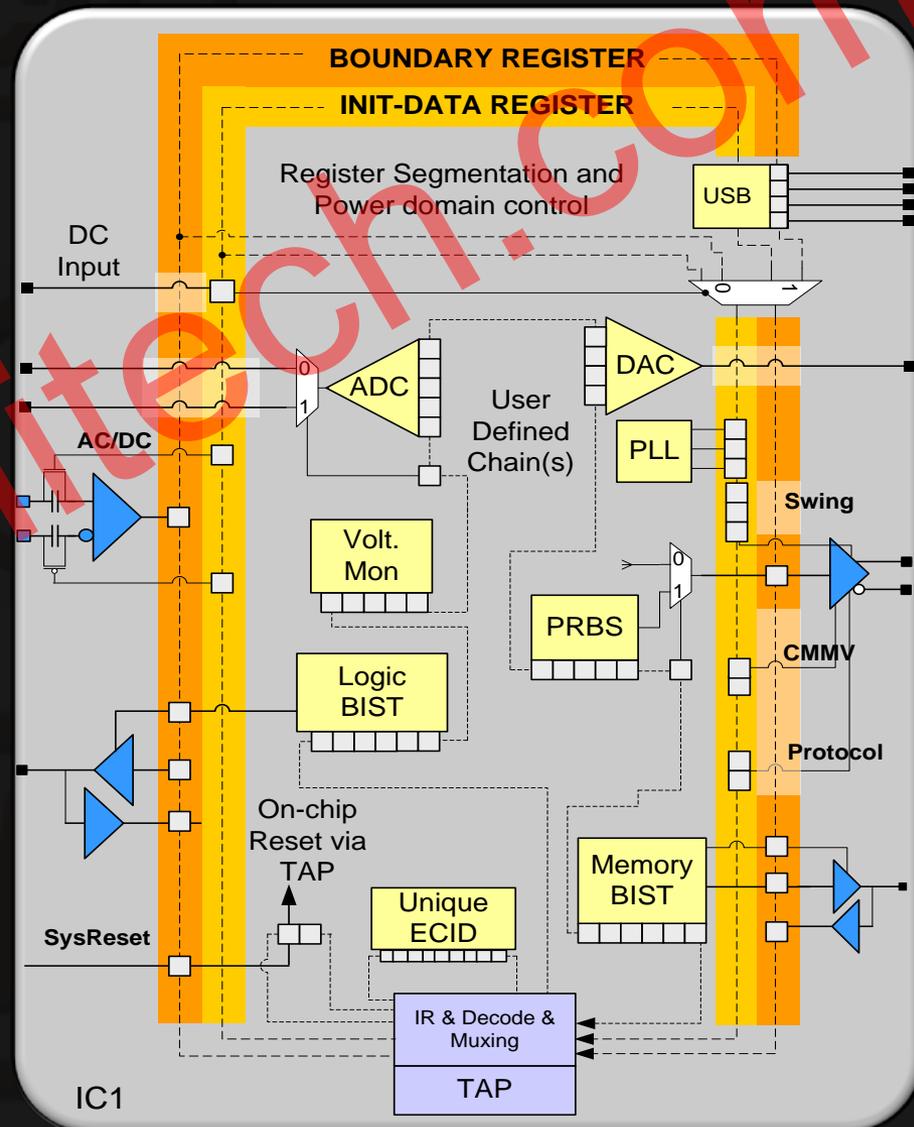
Hierarchical operational language for On-chip IP

Synergy with IEEE 1500 and IEEE 1801

- re-use popular IEEE 1500 structures

- TDRs can cross power domains

444 Pgs vs. 208 pgs in 1149.1-2001



# IEEE 1149.1 is JTAG

Just didn't do a good job in BSDL, fixed length TDRs, flat-chip level descriptions

- Corrected in 1149.1-2013

## 1. Overview

### 1.1 Scope

This standard defines test logic that can be included in an integrated circuit to provide standardized approaches to:

- Testing the interconnections between integrated circuits once they have been assembled onto a printed circuit board or other substrate
- Testing the integrated circuit itself
- Observing or modifying circuit activity during the component's normal operation

The test logic consists of a boundary-scan register and other building blocks and is accessed through a test access port (TAP).

## Advantages of P1687 typically compared with 1149.1-2001

"The results demonstrate the significant advantages of P1687 over the current IEEE 1149.1 (JTAG) 2 test methodology, both in automating the test pattern development and in reducing test setup data volume by more than 50%. "

My Note: no speed up over 1149.1-2013

" AUTOMATED TEST CREATION FOR MIXED SIGNAL IP USING IJTAG "

Keim, et. al. Mentor Graphics, September 2012

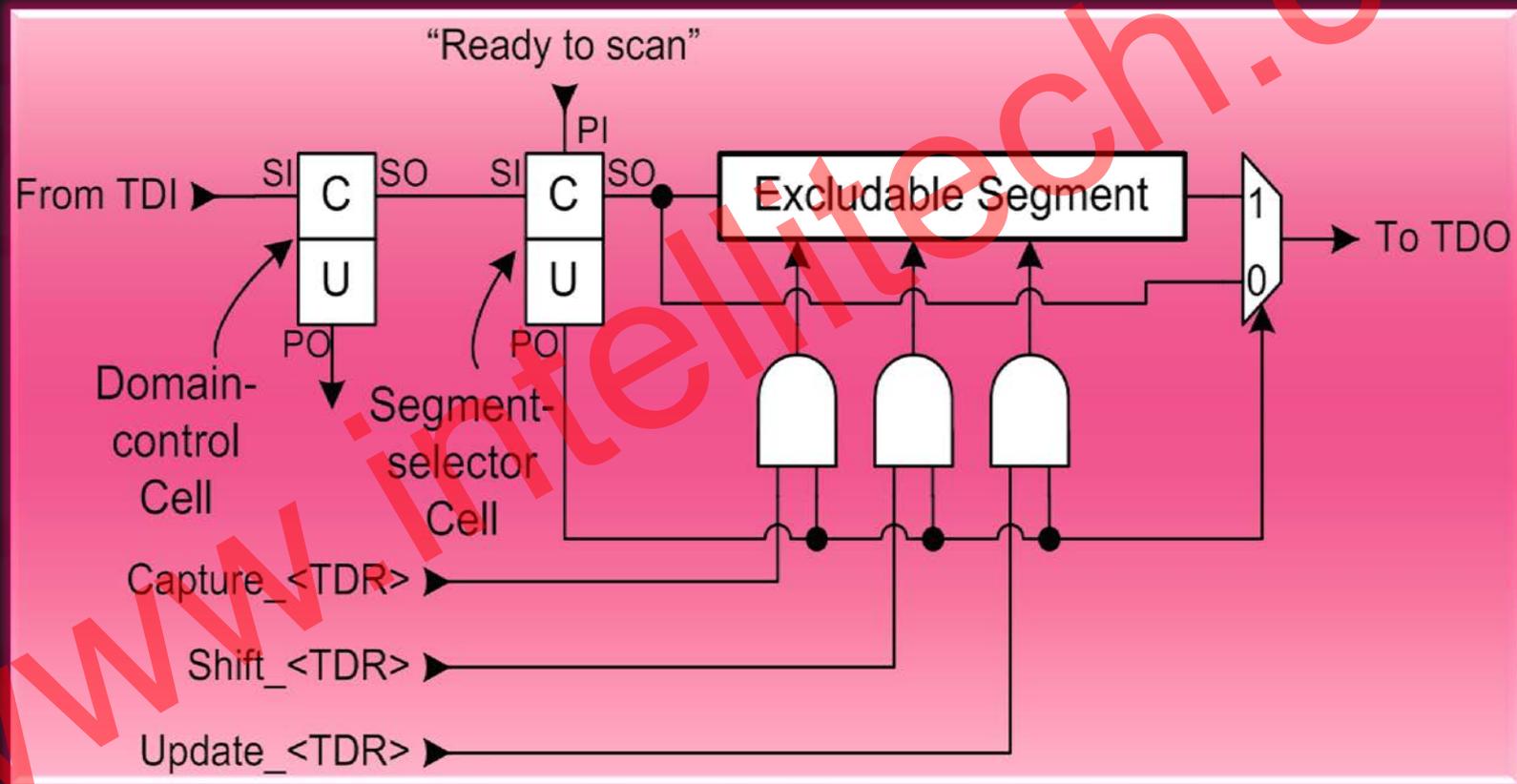
# What DFT engineers care-about in JTAG Is in 1149.1-2013

But with safer instrument operation

No SIB - Safer scans for power domains with SEGSEL

TAP based reset between instrument operation

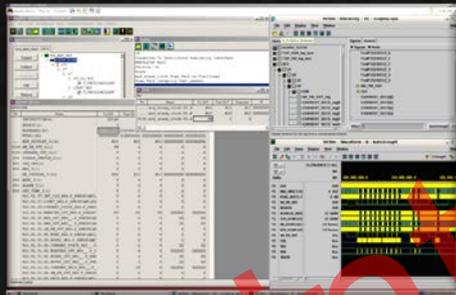
Isolation of core logic from PCB inputs



# IEEE Std. 1149.1-2013 lowers industry costs by enabling test re-use through all phases of the IC life-cycle

- Specifies best practices for Infrastructure IP test interfaces
- Specifies rules for describing IP operation
- Enables one description to be used in all test stages
- Enables defect correlation between system failures and IC ATE

**Note: doesn't require production IC test through TAP**



IP Validation

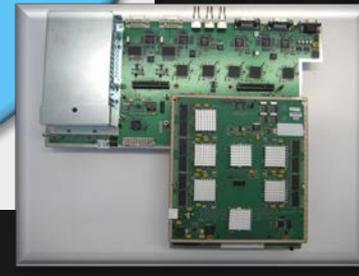
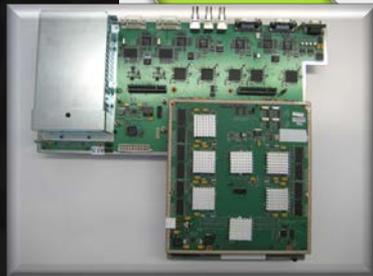
Field Test

**TEST, DEBUG  
CONFIGURATION  
Through IEEE Std.  
1149.1-2013**



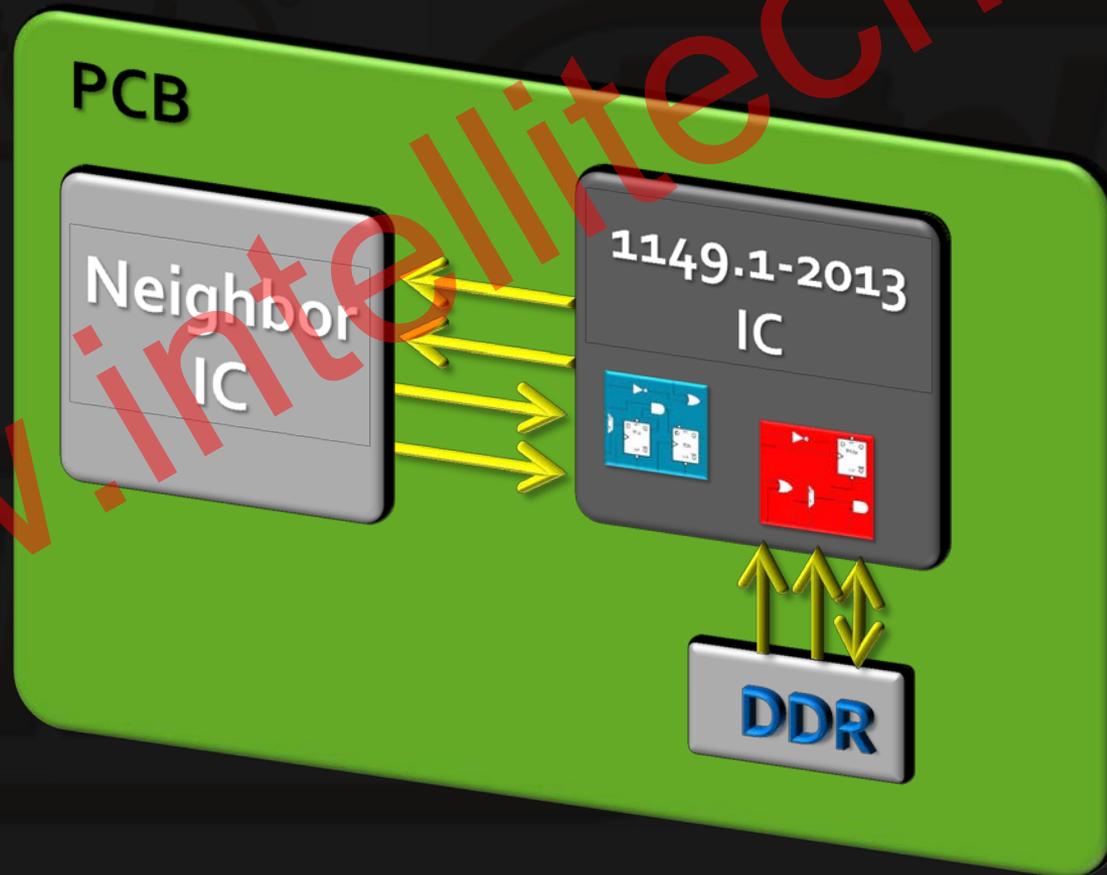
IC Test

Board Test



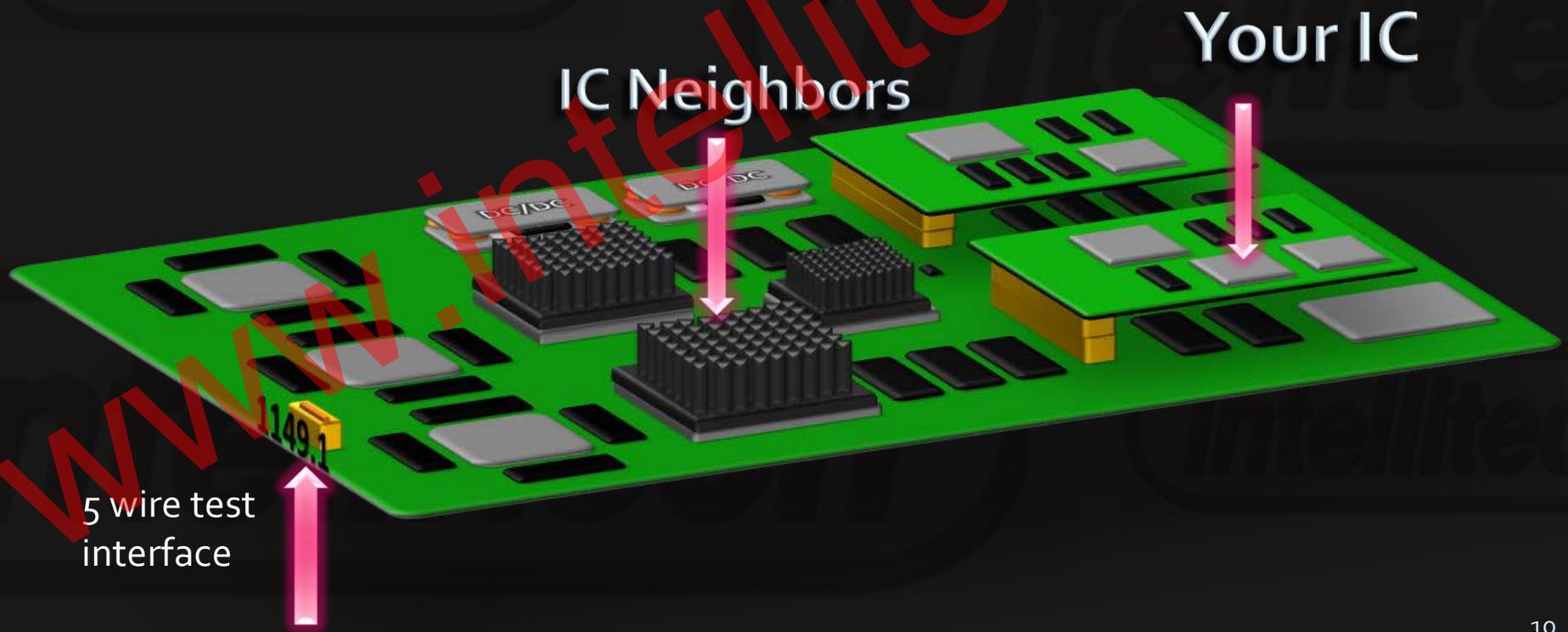
## 1149.1-2013 enables ecosystem tests

- Test the interactions of the IC with supporting PCB components
- Ecosystem tests - valuable for IC customer/system integrator
- Valuable for IC vendor to exonerate/validate to the customer that the IC is working



Only 1149.1-2013 designed for test re-use at card/system  
Hostile card/system environment

- No control of resets, digital I/O to IC
  - 5 wire test bus
- Missing components (floating inputs) can inject noise
- CLAMP\_HOLD/IC\_RESET mitigate of false failures
- Need test re-use for "Adaptive Test"



# 1149.1-2013 enables knowledge transfer

Through the standard hierarchical English-like languages of 1149.1-2013, IP and IC designers can transfer critical expertise to customers

One 1149.1-2013 compliant IP gets leveraged across hundreds of engineers

One 1149.1-2013 compliant IC may have hundreds or thousands of IP



IP Domain Expertise

Closest to source

Furthest

OSAT = Out Sourced Assembly & Test

Total Industry Cost Savings

\$

# Infrastructure Intellectual Property Vendor



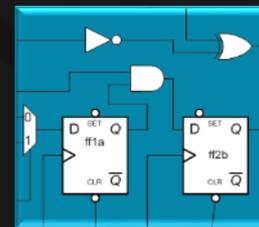
I make infrastructure IP.

How do I ...

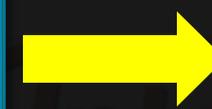
- Make it compatible with other Infrastructure IP?
- Document it so my customer can use it ?
- Minimize support and exonerate my IP when integrated into the customer's IC?

Ex. SERDES PRBS

Verilog description is not enough  
CTL vectors are non-retargetable



IP



IC  
Customer



# IC Designer

## I need Infrastructure IP but...

- a) Documentation is incomplete or unclear
- b) Hundreds of IP - I need automation
- c) How do I exonerate my chip when EMS has a board test problem?
- d) How do I reduce support but enable my customers to do complex ecosystem tests (e.g. test from IC to DDR3 at-speed)?



# System Designer

I need on-chip and ecosystem tests

I want to characterize signal integrity of PCB FR4  
before software has functional tests

Datasheet isn't enough info

How do I run this on-chip IP?

How do I get EMS/Board test up  
to speed quickly?

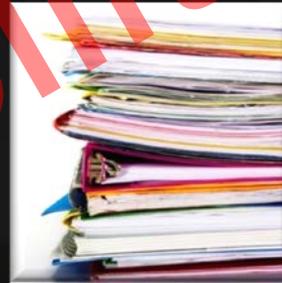


# EMS Test Engineer and OSAT Test Engineer

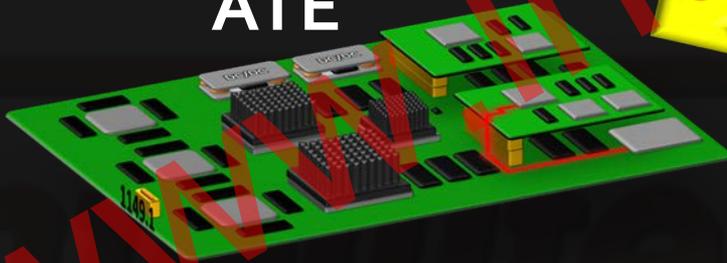


- I have many customers with different IP and different technology, I can't be an expert in all of them
- Test specifications have grown exponentially
- I need a scale-able automated approach

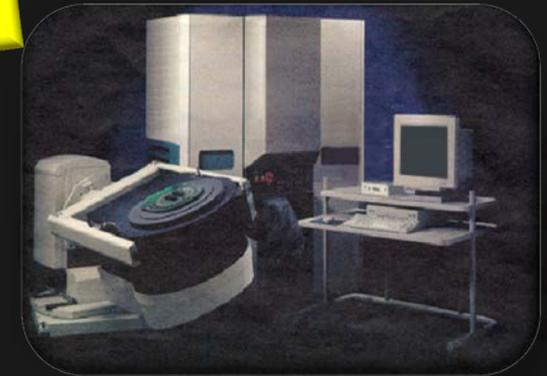
TEST  
SPECIFICATIONS



Board  
ATE

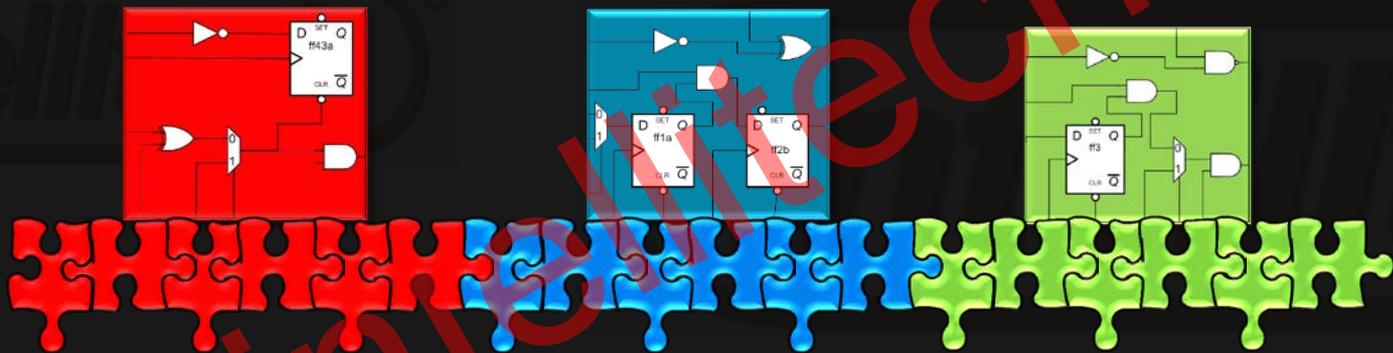


IC ATE

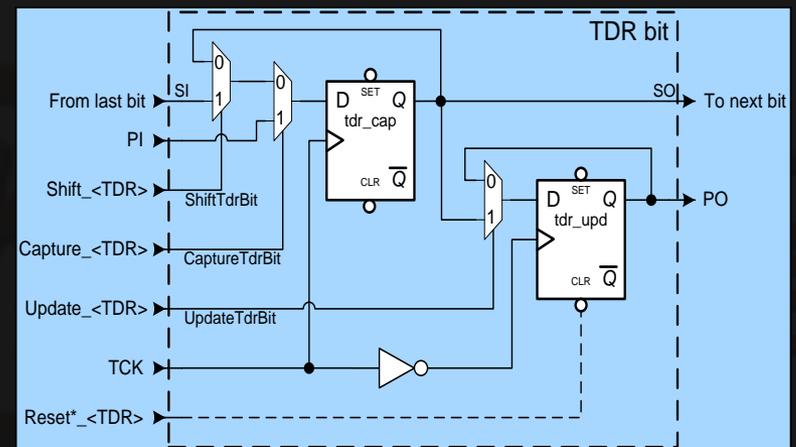


# Solution 1149.1-2013 - Make IP interfaces plug-n-play

- Standardized Test Data Register interface
- Standard defined cell types
- Each cell plugs into the next cell
- Plug-n-play interface

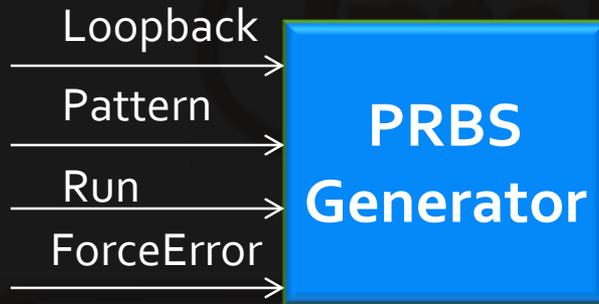


- Follows IEEE 1500 standard Wrapper Serial Ports
- Pre-defined Cell types
- User defined cells allowed



Single bit TDR Cell

## 1149.1-2013 Solution: Standardize IP documentation



- Describe Interface to IP w/o TAP
- Description is "packaged" in compliant IEEE 1149.1-2013 package file
- Describe just interface + mnemonics
- Machine readable

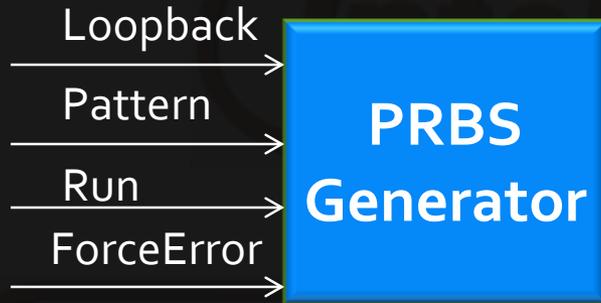
```
Attribute REGISTER_MNEMONICS of SERPRBS : package is
"OnGroup      (ON (1), OFF (0)), " &
"PatGroup     ( PRBS31(1), PRBS23 (2), PRBS7(3) );"
```

```
Attribute REGISTER_FIELDS of SERPRBS : package is
```

```
"PRBS [5] ( "&
  "(Loopback [1] IS (4) DEFAULT(OnGroup(ON))), " &
  "(Pattern [2] IS (3,2) DEFAULT(PatGroup(PRBS7)) ), " &
  "(Run [1] IS (1) SAFE(OnGroup(OFF)) ), " &
  "(ForceError [1] IS (0) DEFAULT(OnGroup(OFF)));"
```

PRBS - Pseudo-Random Bitstream Sequence

# 1149.1-2013 Solution: Standardize IP documentation

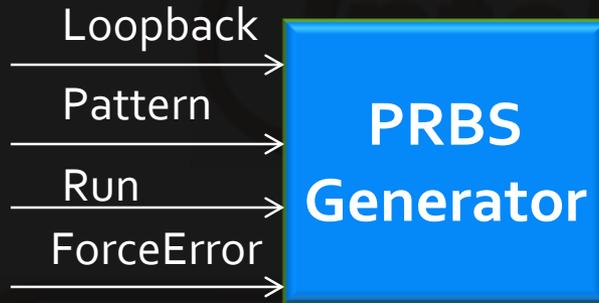


Procedural Description Language  
- new vectorless re-targetable  
language for describing IP operation



Format: **<iWrite >** <Register> <value or mnemonic>

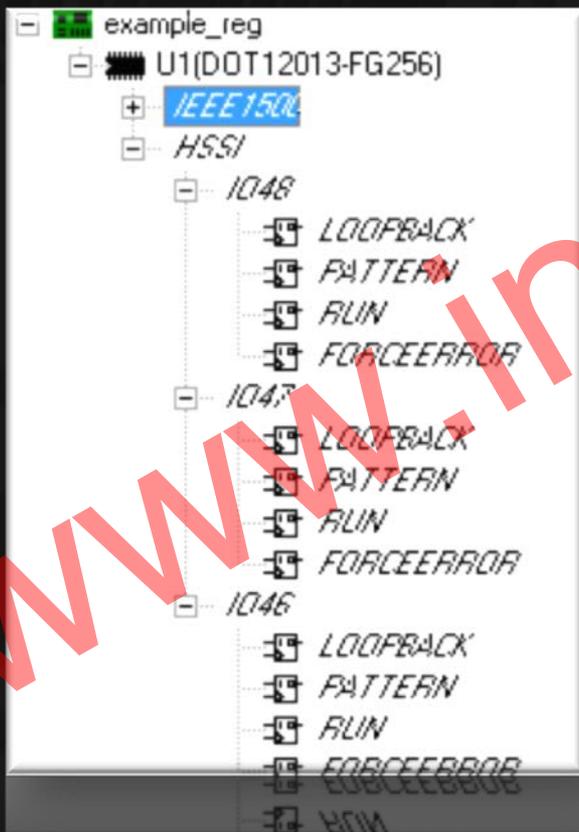
# 1149.1-2013 Solution: Standardize IP documentation



Tools read IP package file hierarchy  
And integrate with top level IC

1149.1-2013 <info tag> specifically provided  
for interactive operation of internal JTAG  
registers

Any instance of any IP can be accessed  
within the IC hierarchy



A screenshot of a window titled "EXAMPLE\_REG.U1.IO48" showing a table of JTAG registers. The table has columns: Pin, Name, Radix, To UUT, From UUT, and Expected. A mouse cursor is pointing at the "OFF" value in the "To UUT" column for the "RUN (1)" entry.

Pin	Name	Radix	To UUT	From UUT	Expected
	U1 . INSTRUCTION (4)	M	SERDES	0100	0001
	LOOPBACK (1)	M	OFF	X	X
	PATTERN (2)	M	PRBS23	XX	XX
	RUN (1)	M	OFF	X	X
	FORCEERROR (1)	M	ON	X	X

# Tools re-target register access for the user



Package SERPRBS

**iWrite** Loopback ON

HSSI



Package SERPRBS  
Package HSSI

Tool converts to: **iWrite** HSSI.IO(48).Loopback 1



Package SERPRBS  
Package HSSI  
IC BSDL

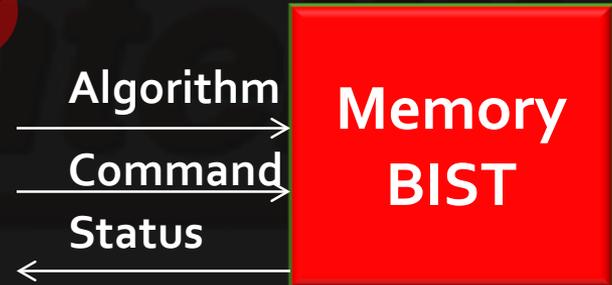
Tool converts to: **iWrite** U1.HSSI.IO(48).Loopback 1

# 1149.1-2013 Solution: Standardize IP documentation

## Memory BIST example "IP package"

**attribute REGISTER\_MNEMONICS of MEMB : package is**

```
"Mode (chkbrd (0B000) <Checkerboard>, "&
" GalPat (0B010) <GALPAT >, " &
" MATS+ (0B101) < March Algorithm >, "&
" MOVI (0B110) < Moving Invert >, "&
" March_C- (0B111) < Unlinked CFins >), "&
"Run (Start (1), " &
" Stop (0) ), " &
"Result (Pass (0B11), " &
" Fail (0B01), " &
" Not_Done (0BX0))";
```



**attribute REGISTER\_FIELDS of MEMB : package is**

```
"MBist [6]( "&
" ( Algorithm[3] IS (5 DOWNT0 3) DEFAULT(Mode (Walk1)) NOUPD ), "&
" ( Command [1] IS (2) DEFAULT(Run (Stop )) ), "&
" ( Status [2] IS (1 DOWNT0 0) CAPTURES(Result(Pass )) ) );
```

**BIST = Built-in Self Test**

## 1149.1-2013 Solution: Standardize IP documentation

PDL Description of how to operate MemoryBIST IP  
Memory\_bist procedure takes Algorithm and clock source

```
# MEMB.pdl
iPDLLevel 0 -version STD_1149_1_2013
iProcGroup MEMB
iProc memory_bist {alg clk} {

    iWrite Algorithm $alg
    iWrite Command Start
    iApply
    iRunLoop 10000 -sck $clk
    iRead Status Pass
    iApply }
}
```



"Without 1149.1 based I/O initialization, it could take a whole month on the IC ATE to configure the I/O for parametric testing on a complex SoC using functional test methods "

- IC Test Engineer

Major OEM Company

(It's no easier at the board level!)

# 1149.1-2013 Solution: I/O parameters on new "init\_data" TDR

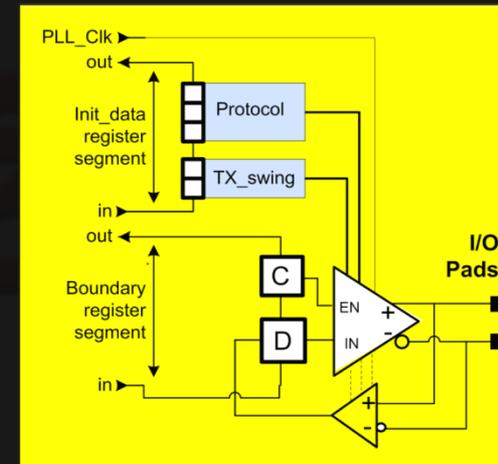
```
package body MyCorp_SERDES is
  use STD_1149_1_2013.all;

  attribute REGISTER_MNEMONICS of MyCorp_SERDES : package is
```

```
"SerDes_Protocol ( "&
" off (0b000) <Powered down>,"&
" SATA (0b010) <Serial Adv. Technology Attachment>,"&
" SRIO (0b011) <Serial RapidIO>,"&
" XAUI (0b101) <10Gbps Attachment Unit Interface>,"&
" Resvd1 (0b100) <Reserved for Future Use>,"&
```

```
"SerDes_TX_Outputs ( "&
" off (0b00) <Powered down>,"&
" Full_Swing (0b01) <100% Vdd Swing>,"&
" 75%_Swing (0b10) <75% Vdd Swing>,"&
" 52.7%_Swing (0b11) <Not valid for XAUI>");
```

```
attribute REGISTER_FIELDS of MyCorp_SERDES : package is
"Channel [5] ( "&
"(Protocol [3] IS (2,0,1) SAFE (SerDes_Protocol(*))), "&
"(TX_Swing [2] IS (3,4) SAFE (SerDes_TX_Outputs(*))) "&
" ); "
end MyCorp_SERDES;
```

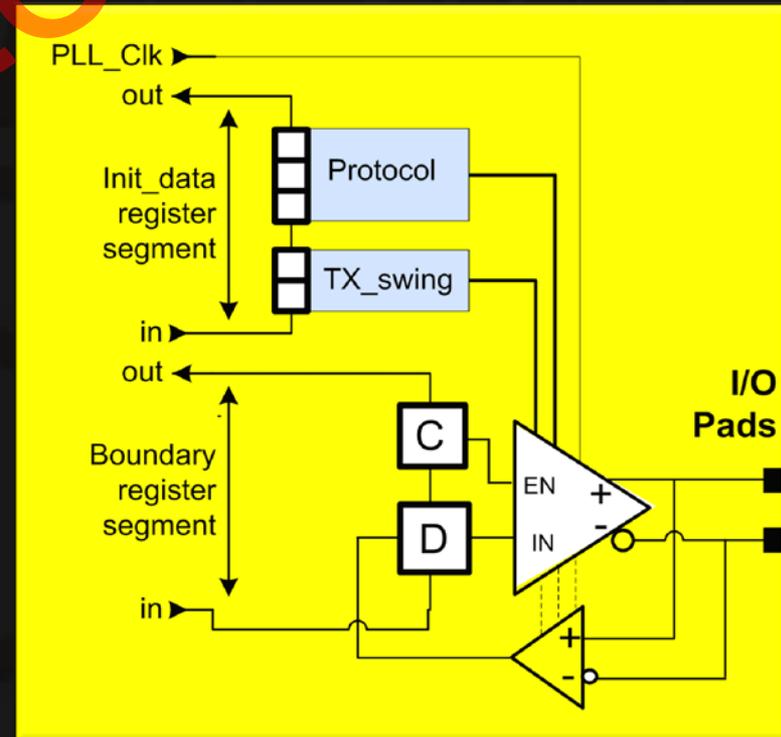


# 1149.1-2013 Solution: I/O parameters on new "init\_data" TDR

```
# MyCorp_SERDES.pdl
iPDLLevel 0 -version STD_1149_1_2013
iProcGroup MyCorp_SERDES

iProc init_setup {} {

    iWrite Protocol XAUI
    iWrite TX_Swing 75%_Swing
    iApply
}
```





# IEEE 1149.1-2013 and IEEE 1500

## Concise Description of 1500 architecture and WIR mnemonics

This 1500 architecture provides access to **MBIST** from vendor "EDA\_ABC"

Attribute REGISTER\_MNEMONICS of REG\_1500 : package is

```
"WIR_decode ( "&
  "WS_BYPASS (0B0000) <Wrapper Bypass Instruction>, "&
  "WS_EXTEST (0B0001) <Wrapper Extern Boundary Instr>, "&
  "WS_INTEST (0B0010) <Wrapper Intern Boundary Instr>, "&
  "WS_BIST (0B0100) <BIST Instruction>, "&
  "WP_ALL (0B1xxx) <Wrapper Parallel instructions> "&
  " )" & -- end of WIR_decode
  " )"; -- end of REGISTER_MNEMONICS
```

Attribute REGISTER\_ASSEMBLY of REG\_1500 : package IS

```
-- The Select WIR bit and the Wrapper Serial Port
"REG_1500 ( " & -- Reset to WBY
  "(SELWIR [1] DelayPO ResetVal(0b0) TAPReset ), "&
  "(WSP IS WSP_MUX) ), "& -- end of REG_1500
  "WSP_MUX ( "& -- The outer segments: WIR and WDR
    "(SelectMUX "&
      -- Reset to WBY
      "(WIR IS WIR_Seg), "&
      "(WDR IS WDR_MUX) "&
      "SelectField (SELWIR) "&
      "SelectValues ((WIR : 0b1) (WDR : 0b0)) ) ), "&
      -- end of SELECTMUX end of WSP_MUX
    "WIR_Seg ( (WIR_field [4] "&
      "ResetVal(WIR_decode(WS_BYPASS)) TAPReset)), "&
    "WDR_MUX ( "& -- The inner segs: WBY, WBR, and Wusr
      "(SelectMUX "&
        "(WBY IS Reg_WBY CAPTURES(0) ), "&
        "(WBR IS Reg_WBR), "&
        "(WUSR IS Package EDA_ABC: MBIST) "&
        "SelectField (WIR) "&
        "SelectValues ( "&
          "(WBY : WS_BYPASS, WP_ALL) "&
          "(WBR : WS_EXTEST, WS_INTEST) "&
          "(WUSR : WS_BIST) "&
          " ) "& -- end of SelectValues
        " ) "& -- end of SelectMUX
      " ), "& -- end of WDR_MUX
    "REG_WBY ( (WBY[1] NOPO)), " &
    "REG_WBR ( (WBR[8] ))" &
  end REG_1500;
```

The image shows two screenshots from a logic simulator. The top screenshot is titled 'EXAMPLE\_REG.U1.IEEE1500.MBIST' and shows a table of register values. The bottom screenshot is titled 'EXAMPLE\_REG.U1.IEEE1500.WRAPPER' and shows a similar table with a dropdown menu open over the 'WIR' register, listing various wrapper instructions.

Pin	Name	Radix	To UUT	From UUT	Expected
	U1.INSTRUCTION (4)	M	ENA_1500	0100	0001
	ALGORITHM (3)	M	CHKBRD	011	XXX
	COMMAND (1)	M	START	0	X
	STATUS (2)	M	00	NOT_DONE	XX

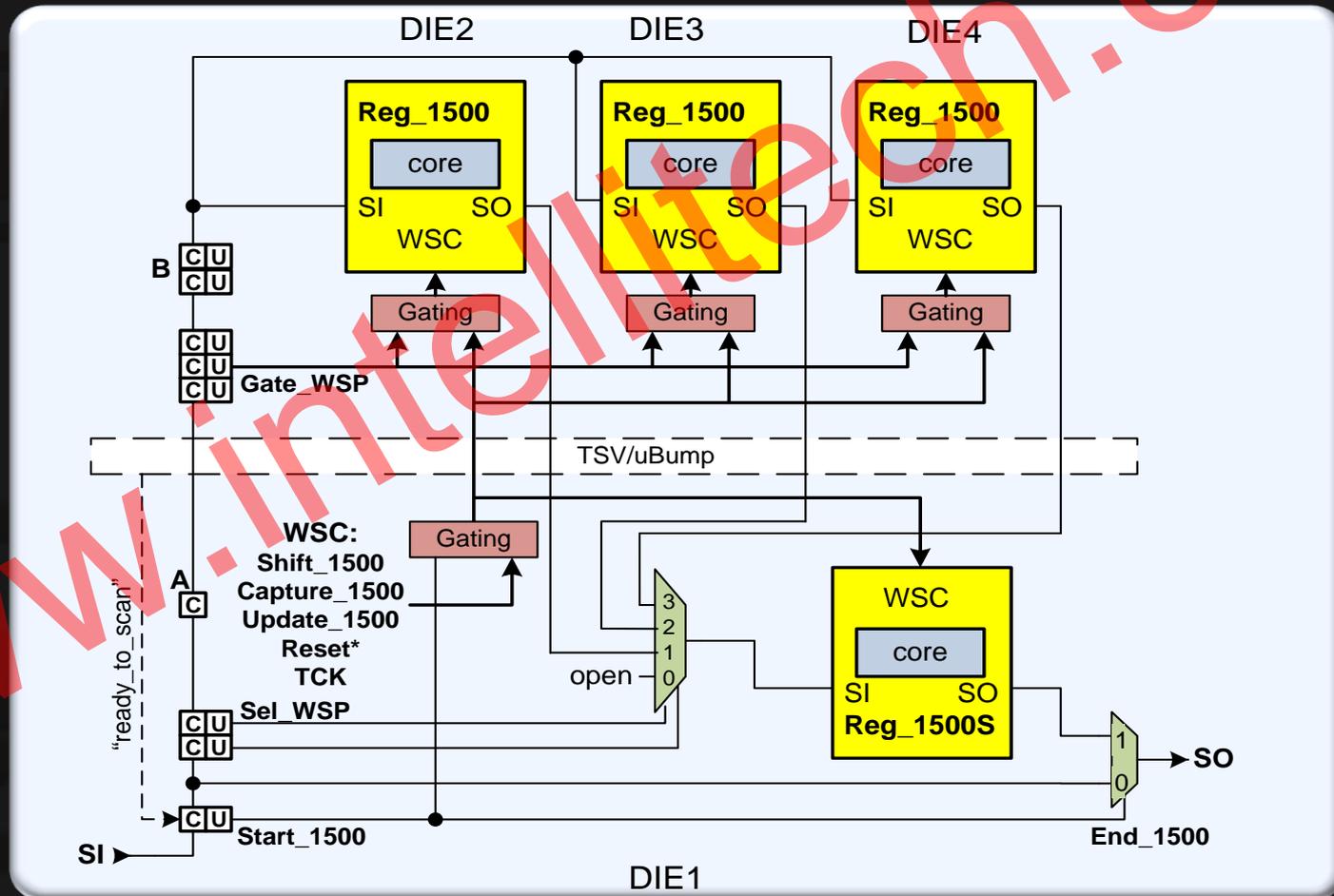
  

Pin	Name	Radix	To UUT	From UUT	Expected
	U1.INSTRUCTION (4)	M	ENA_1500	0100	0001
	WIR (4)	M	WS_BYPASS WS_EXTEST WS_INTEST WS_BIST WS_ALL	0100	XXXX
	WBR (490)	H	54A	3FE00C900	XXXXXXXXXX
	WBY (1)	B		0	X

# IEEE 1149.1-2013 and IEEE 1500

IEEE 1149.1-2013 expands IEEE 1500 Wrapper Serial Ports

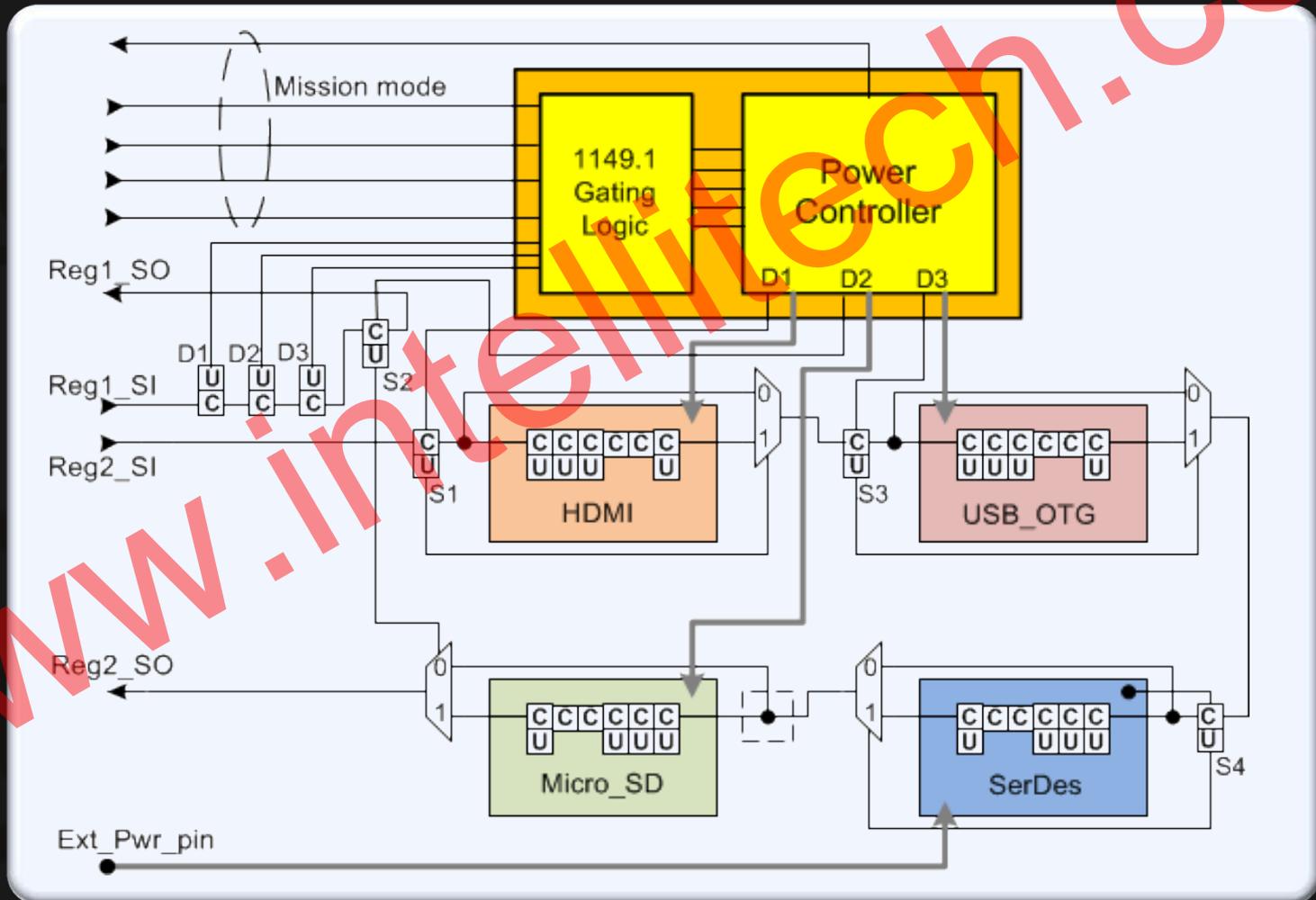
- Provides for standardized low power Domain/DIE crossing
  - Only standard which observes/controls power for a segment
- Attribute **REGISTER\_ASSOCIATION** enables TSV -to-register mapping
- Supports **BROADCAST** to IEEE 1500 WSPs



# IEEE 1149.1-2013 and IEEE 1801

Standardizes Test Data Register segmentation implemented by IEEE 1801 power intent. Both standards now use Tcl as the standard language.

Standardizes the input and description of on-chip or off-chip power control



## IEEE 1149.1-2013 New IC level Instructions

INIT\_SETUP  
INIT\_SETUP\_CLAMP  
INIT\_RUN

IC\_RESET

ECIDCODE

CLAMP\_HOLD  
CLAMP\_RELEASE  
TMP\_STATUS

Three Instructions for initializing programmable IP connected to I/O pins

Standardized on-chip per domain system reset

Unique per die identifier

Standardizes a method to hold and isolate I/O pins during in-situ test of an IC

## ECID to prevent Counterfeiting by re-marking

Problem: Supply chain re-marking of parts to alter speed grade or Temp (C/I)  
- 3<sup>rd</sup> parties have little resources to test/validate

Solution: IEEE 1149.1-2013 ECID programmed with rated temp/speed in OTP efuse/NVM



Tracking/Correlation ECID can be defined or made private

- shown for convenience
- Can also be encrypted/scrambled

Grading information should be made public

Values programmed during test/binning/burn-in by trusted OSAT (Out Sourced Assembly and Test) house

# 1149.1-2013 ECID Package definitions

**attribute REGISTER\_MNEMONICS of ECID : entity is**

```
"Temp (Comm (0B00) < Commercial >, "&
"      Ind  (0B10) < Industrial >, " &
"      AEC  (0B01) < AEC-Q100 >), "&
"Speed (S1   (1), " &
"      S2   (0) ), " &
"Stat  ( Ready      (1), " &
"      Not_Ready  (0) ) ";
```

**attribute REGISTER\_FIELDS of ECID : package is**

```
"ECID [35]( "&
" ( Status [1] IS (34) CAPTURES(Stat (Not_Ready)) ), "&
" ( Temp [2] IS (33 DOWNT0 32) CAPTURES(Temp (-)) ), "&
" ( Speed[1] IS (31) CAPTURES(Speed (-)) ), "&
" ( Die [9] IS (30 DOWNT0 22) ), "&
" ( Wafer[20] IS (21 DOWNT0 2) ), "&
" ( Fab [2] IS (1 DOWNT0 0) ) );
```

# 1149.1-2013 ECID Procedural Definition Language

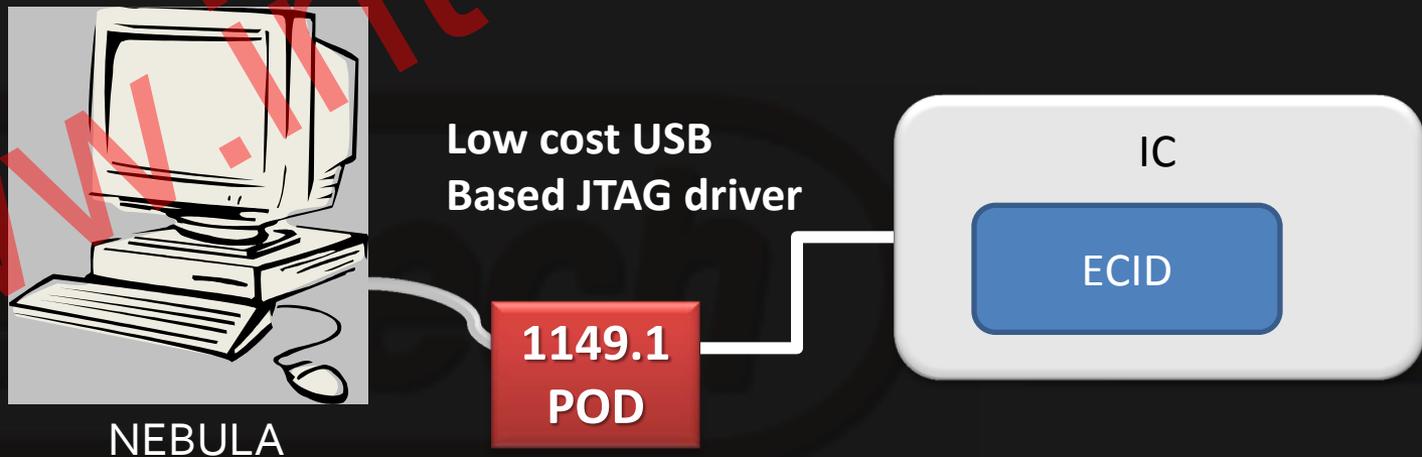
Setup that public/3<sup>rd</sup> parties can use to validate IC grades match the package markings.

- Key is making source PDL publicly available for use with free 1149.1-2013 compliant software
- use low cost ~US\$250.00 Xilinx pod

Output:

This IC grading is Temp:AEC and Speed:S2

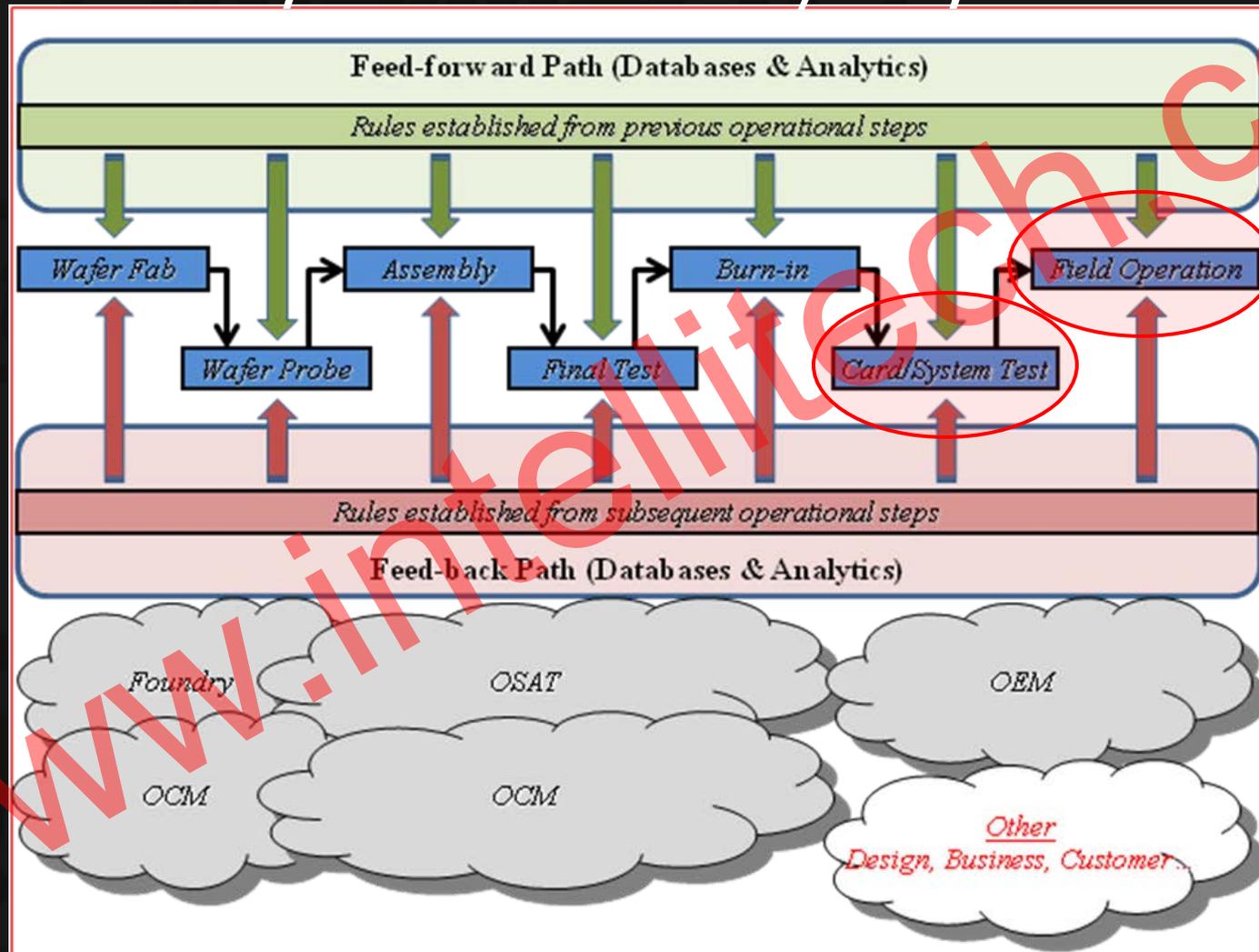
Free 1149.1-2013 compliant software



# IEEE 1149.1-2013 plays a role in ITRS Adaptive Test

- LPC (Tap, clocks, compliance enable)

- ECID, Isolation from ecosystem, TAP based reset



Courtesy of Phil Nigh, IBM ITRS "Adaptive Test" section chair

Closing Thoughts

[www.intellitech.com](http://www.intellitech.com)

"From a cost stand point, having one way to communicate to an on-chip IP that works, is far better than having 100 different ways to learn and exonerate on each IC"

- Director of Engineering  
Tier 1 Semiconductor Supplier

**1149.1-2013 flexibility allows for any design power/speed/complexity  
but 1149.1-2013 architecture and rules enable any customer to drive  
a compliant IC without re-training**

**IEEE 1149.1-2013 and IEEE 1500 help combat  
'anything goes' DFT creativity**



**Creativity: Good here**



**Not good here**

- **Cost savings occur when interfaces are familiar, consistent, repeatable and don't require new training or analysis**

# Development Environment for 1149.1 Silicon Instruments

Free NEBULA tool - reads 1149.1-2013 BSDL and PDL

<http://www.intellitech.com/ijtag>

The screenshot displays the NEBULA development environment with several key components:

- Register Viewer:** A table listing various registers and their expected values.
- Instrument Browser:** A tree view showing the hierarchy of instruments and registers.
- Breakpoints:** A window for setting and managing breakpoints.
- Event Triggers:** A dialog box for configuring event triggers, such as CSR ON.
- PDL/TCL Single Steppers:** A script editor showing PDL/TCL code for controlling the instrument.
- Timing Analyzer:** A window for analyzing timing data, showing a table with columns for marker, distance, and signal.

Pin	Name	To UUT	From UUT	Expected
	WR_DLY_REG (4)	1	X	X
	SH_BUS_REQL_REG (1)	0	U	U
	SCC_CSL_REG (1)	1	U	U
	SCND_STAT_ENL_REG (1)	2	U	U
	RTC_CSL_REG (1)	1	U	U
	PIC_WEL_REG (1)	1	U	U
	MACIO_REQL_REG (1)	1	U	U
	LOAD_WRCNT_REG (1)	0	U	U
	LDB_ENL_REG (2)	0	U	U

Marker	Marker Distance	Trigger Distance	Signal
1		1-DR	
		2-DR	4234
		3-DR	7383

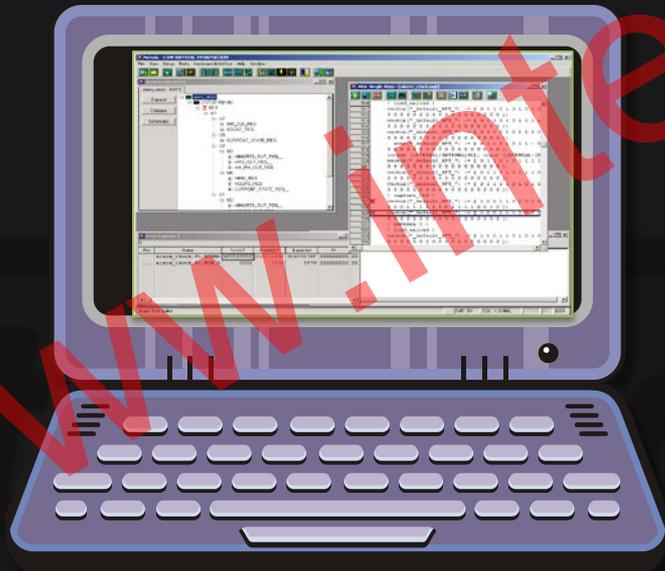
```
# Demonstration of IJTAG/P1687 Register write/read
# Control Config Register
iWrite UO_RDY_GEN_TOP.UO_RDY_REG.RDY_CFG_3_REG 4 d
# Turn on blink register
iWrite UO_CLK_RST_TOP.UO_CLK_RST_P.BLINK_REG 1 d
# Enable the flash
iWrite ADDR_DEC.UO_PERIPH_CTRL.FLASH_WEL_REG 1 d
# Instrument A
iWrite ADDR_DEC.UO_PERIPH_CTRL.CLOCK_VAL_REG 0x5
# Instrument B
iWrite ADDR_DEC.UO_PERIPH_CTRL.CLOCK_VAL_REG 0xA

# load new values
iApply

set result [iRead U1.UO_DRAM_CTL_TOP.UO_DRAM_CTL_TOP.CSR_10_REG]
puts "Reference state for DRAM controller is $result"
```

# Pre-silicon Validation of 1149.1-2013 IP package and PDL

**NEBULA  
JTAG  
Debugger**



# NEBULA - 1149.1-2013 Tcl based silicon instruments (embedded or external)

**GPIB Control Window**  
HEWLETT E3631A 0-6V, 5A0- +/- 25V, 1A  
PACKARD TRIPLE OUTPUT DC POWER SUPPLY

3.356V 0.002A

Adrs Rms +6V

+6 +25 -25 Track Display Limit

3.35 .1 Voltage Current

APPLY

Recall Store Error I/O Config Output On/Off

**s3an\_demo.U2.DAC1 :: LTC2624**

LTC2624 4-Channel 12-bit Digital-to-Analog Converter

Vref VrefLo Vout

Ch A 3.30 2.50

Ch B 3.30 1.20

Ch C 3.30 3.30

Ch D

**s3an\_demo.U2.ADC1 :: LTC1407-1**

LTC1407-1 2-Channel 12-Bit Analog-to-Digital Converter

Vref Voltage

Ch 0 1.65 0.75 V

Ch 1 1.65 2.90 V

Read ADC

**s3an\_demo.U2.AMP1 :: LTC6912-1**

LTC6912-1 2-Channel Programmable Gain Amplifier

Gain Verify Data

Ch A	Ch B	Ch A	Ch B
ZERO	ZERO	X_2	X_5
X_1	X_1		
X_2	X_2		
X_5	X_5		
X_10	X_10		

Update

# Other standards building on 1149.1-2013

## P1149.6-2014?

Leverages 1149.1-2013 BSDL

Uniform specification of the

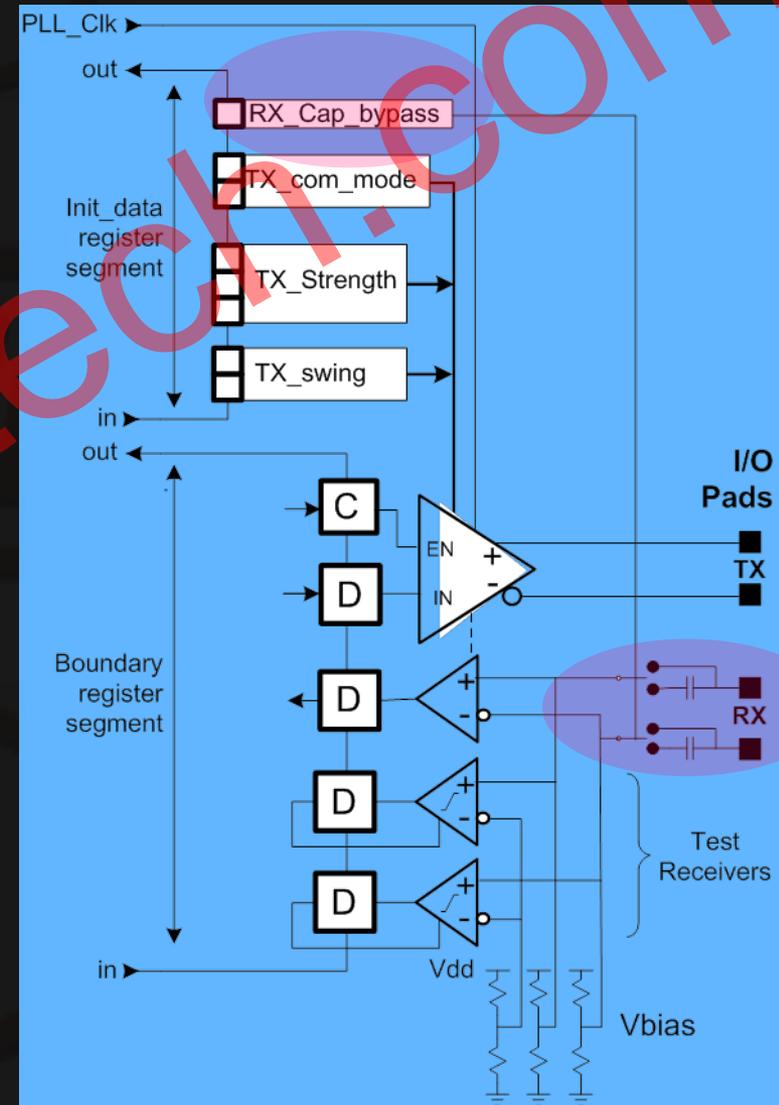
INIT\_DATA Register

Which deselects

on-chip AC coupling cap

```
"SerDes_RX_CapBypass ( "&      -- Only 2 valid settings
    "  Inline_cap (0b0), "&
    "  Bypass_cap (0b1), "&
    " )" ;

attribute REGISTER_FIELDS of MyCorp_SERDES_1_2_3 : package is
-- Init data register segment
"Channel [8] ( "&
    "( TX_Swing [2] IS (7,6)      SAFE (SerDes_TX_Swing(*)), "&
    "( TX_Strength [3] IS (5:3)   SAFE (SerDes_TX_Strength(*)), "&
    "( TX_Common_mode [2] IS (2,1) SAFE (SerDes_TX_ComMode(*)), "&
    "( RX_Cap_Bypass [1] IS (0)   SAFE (SerDes_RX_CapBypass(*))
                                USER : Cap_Bypass_Control ) "&
    " )" ;
```



# P1149.10 High-Speed JTAG "study group"

PAR Submitted July 2013

Re-use Mission mode PHY/PMA/PCS

PMA= Physical Media Access

PCS = Physical Coding Sublayer

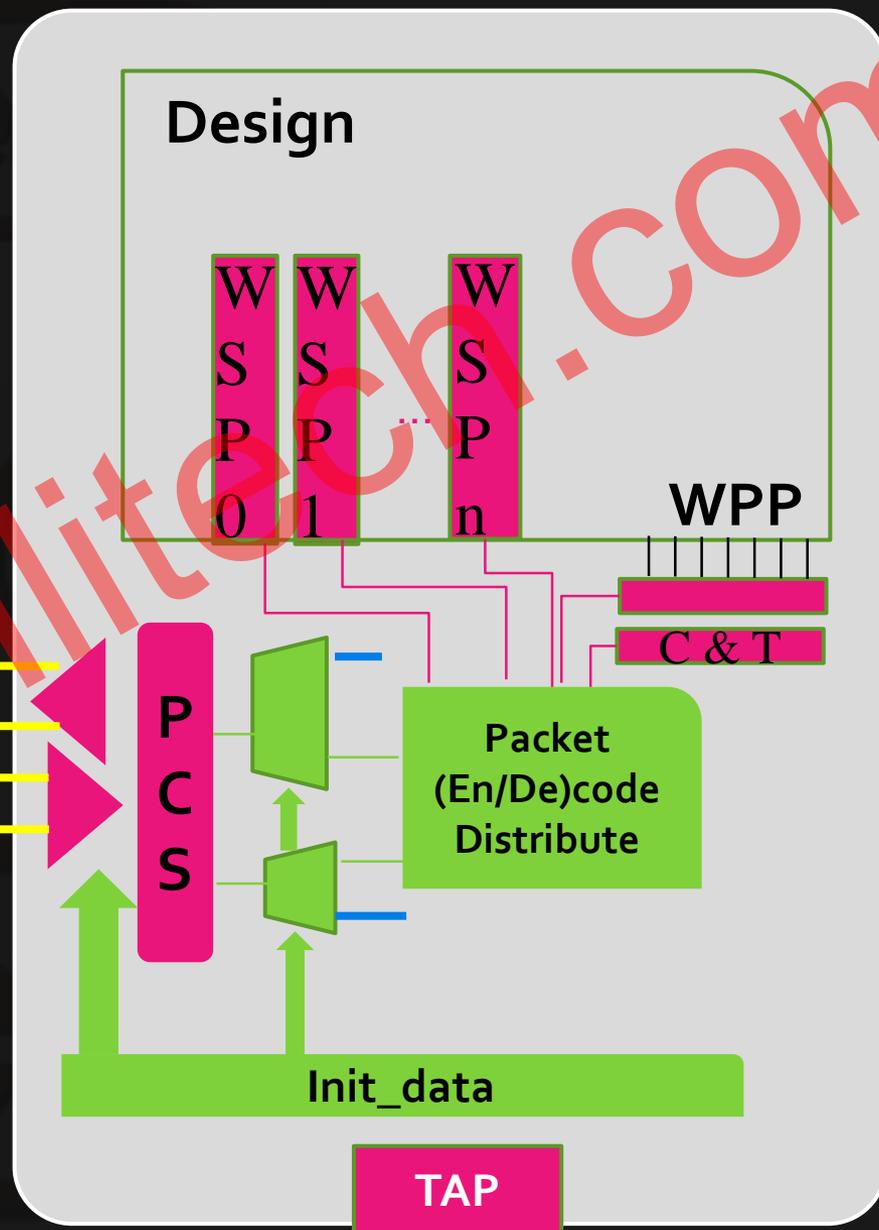
- 8/10/16/20/32/40 width

Re-direct to P1149.10 packet to  
(En/De)code and distribution matrix

Test of P1149.10 circuitry  
via TAP or other means

EDA tools see just "design logic"  
As traditional IEEE 1500 design  
(No new ATPG needed)

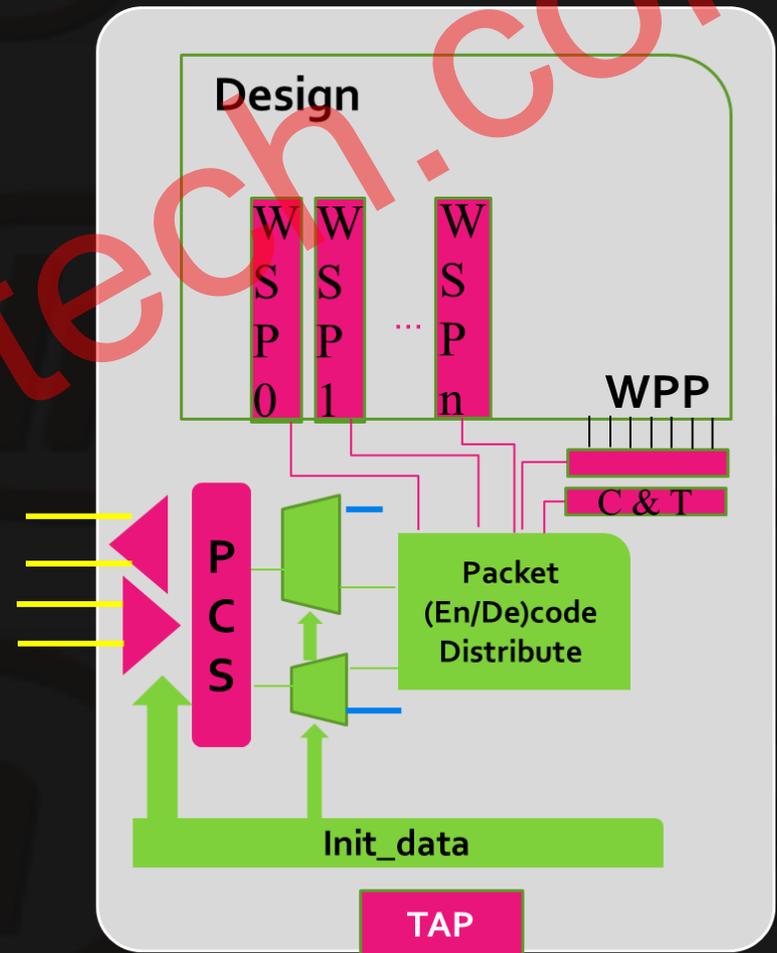
On-chip control & timing



# P1149.10 High-Speed JTAG

Drive 1500 Wrapper Serial Ports and WPP

- High-Bandwidth from ATE to IC  
6-11gb/s or more
- No parallel interface to on-chip scan chains
  - LPCT, ( 8 pins)
  - Simpler ATE timing
  - Loss of contact points due to 3D Stacks
- Higher WSP count on-chip
  - Lower shift rates,
  - Reduce power
  - Reduce compression
- In-system re-usable IC test



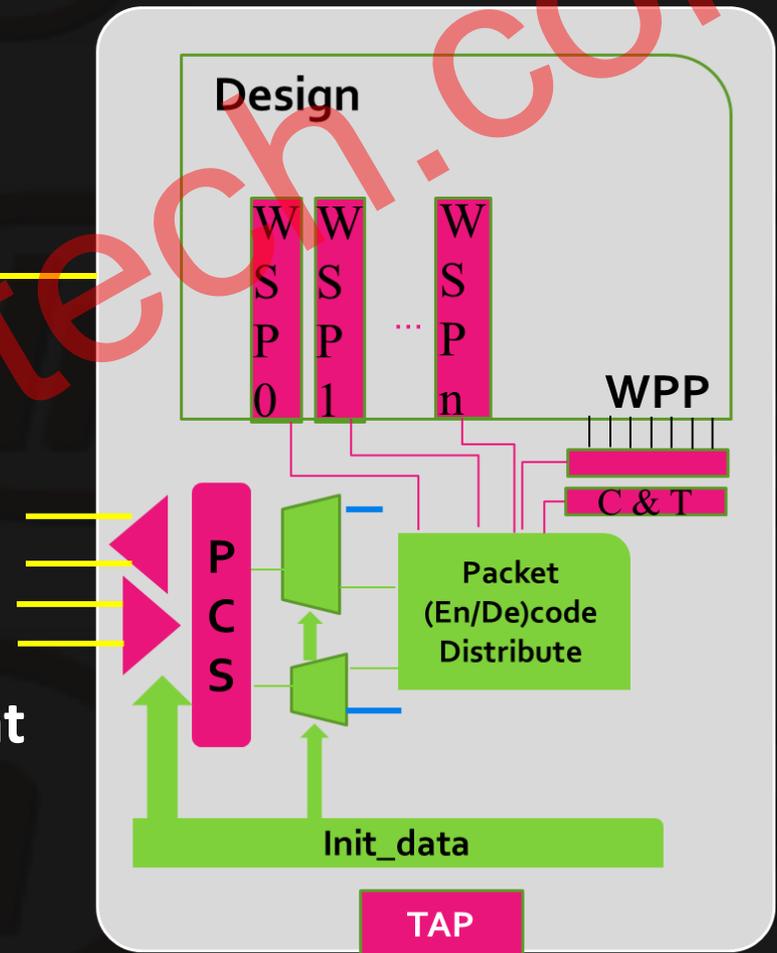
# P1149.10 High-Speed JTAG

Pin access for tester  
(apply patterns over SERDES  
and stop)

Pin access

On-chip Silicon instruments with  
1149.1 or 1149.10 access.

Direct Pin access to silicon instrument  
challenging since no easy way to  
Synchronize



**For 23 years IEEE 1149.1 compliance has been a requirement for many ASIC and SoC contracts**

**Purchase Orders from Silicon vendors for on-chip infrastructure IP will also include requirements for IEEE 1149.1-2013 compliance**



**OEM Purchase Orders will include requirements for 1149.1-2013 compliance and IP with compliant documentation. OEM's will require the 1149.1- 2013 features for test.**

**The 1149.1 brand continues To give assurances to Customers that IP and ICs Meet an acceptable Level of simplicity for Test Re-use**

1149.1-2013 - It's an evolution!

<http://grouper.ieee.org/groups/1149/1>